

ATTY DKT. NO.: AMAT/7385/CMP/ECP/RKK
U.S. SERIAL NO.: UNKNOWN
FILED: HEREWITH
APPLICANT: APPLIED MATERIALS, INC.
TITLE: HOMOGENEOUS COPPER-PALLADIUM ALLOY PLATING FOR ENHANCEMENT
OF ELECTRO-MIGRATION RESISTANCE IN INTERCONNECTS
INVENTOR: PADHI, ET AL.
EXPRESS MAIL NO.: EV349851973US PAGE 1 of 4

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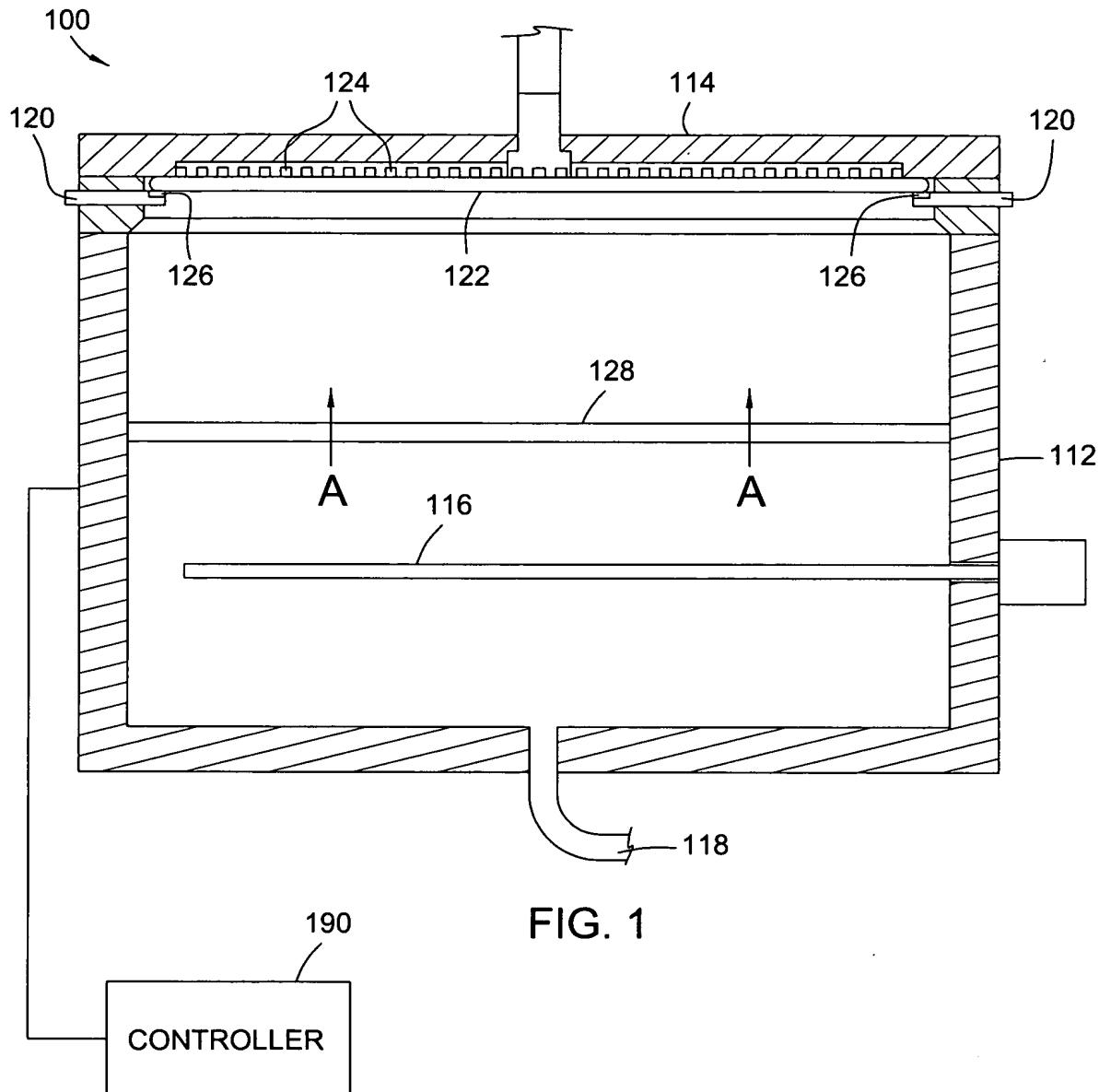


FIG. 1

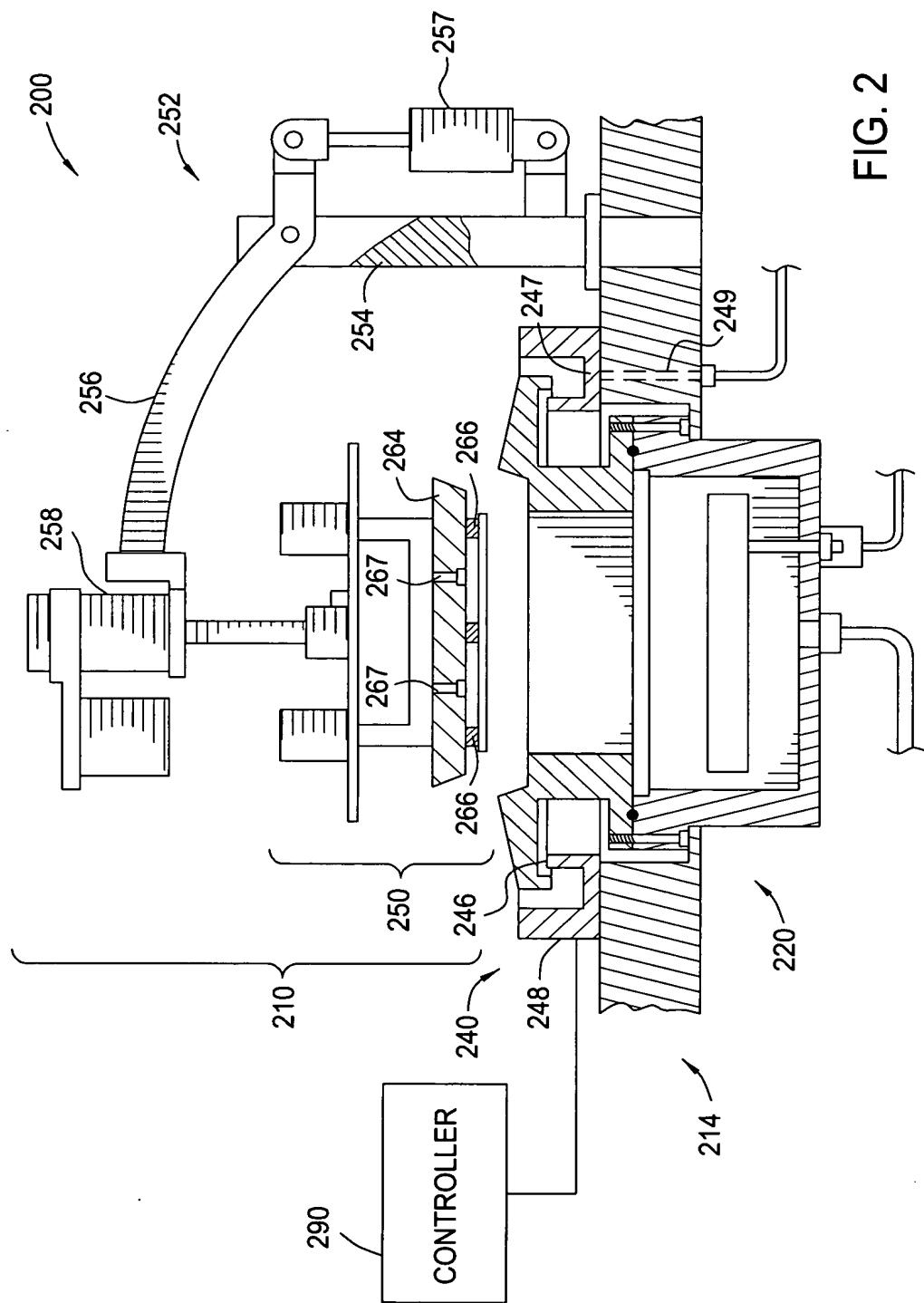


FIG. 2

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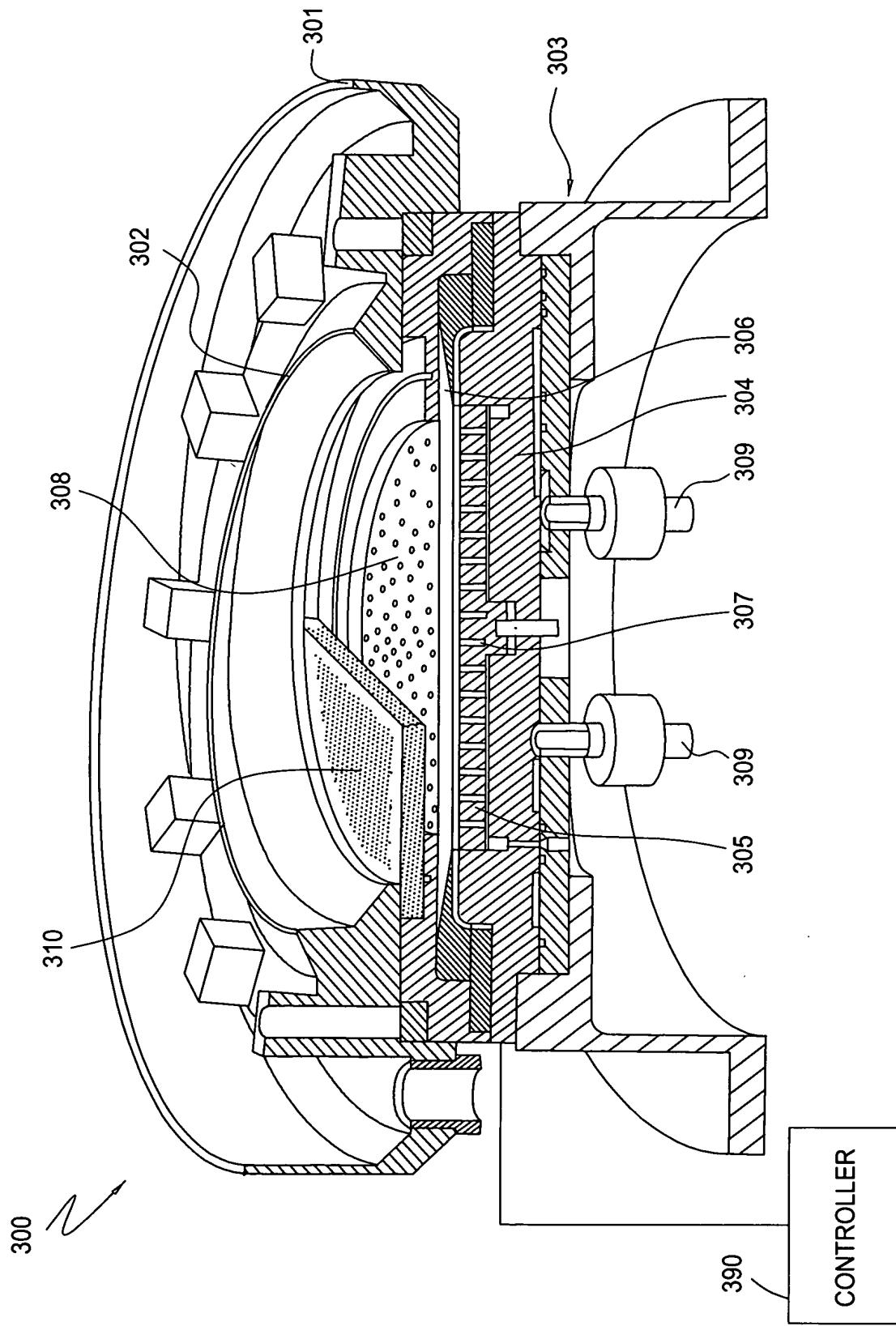


FIG. 3

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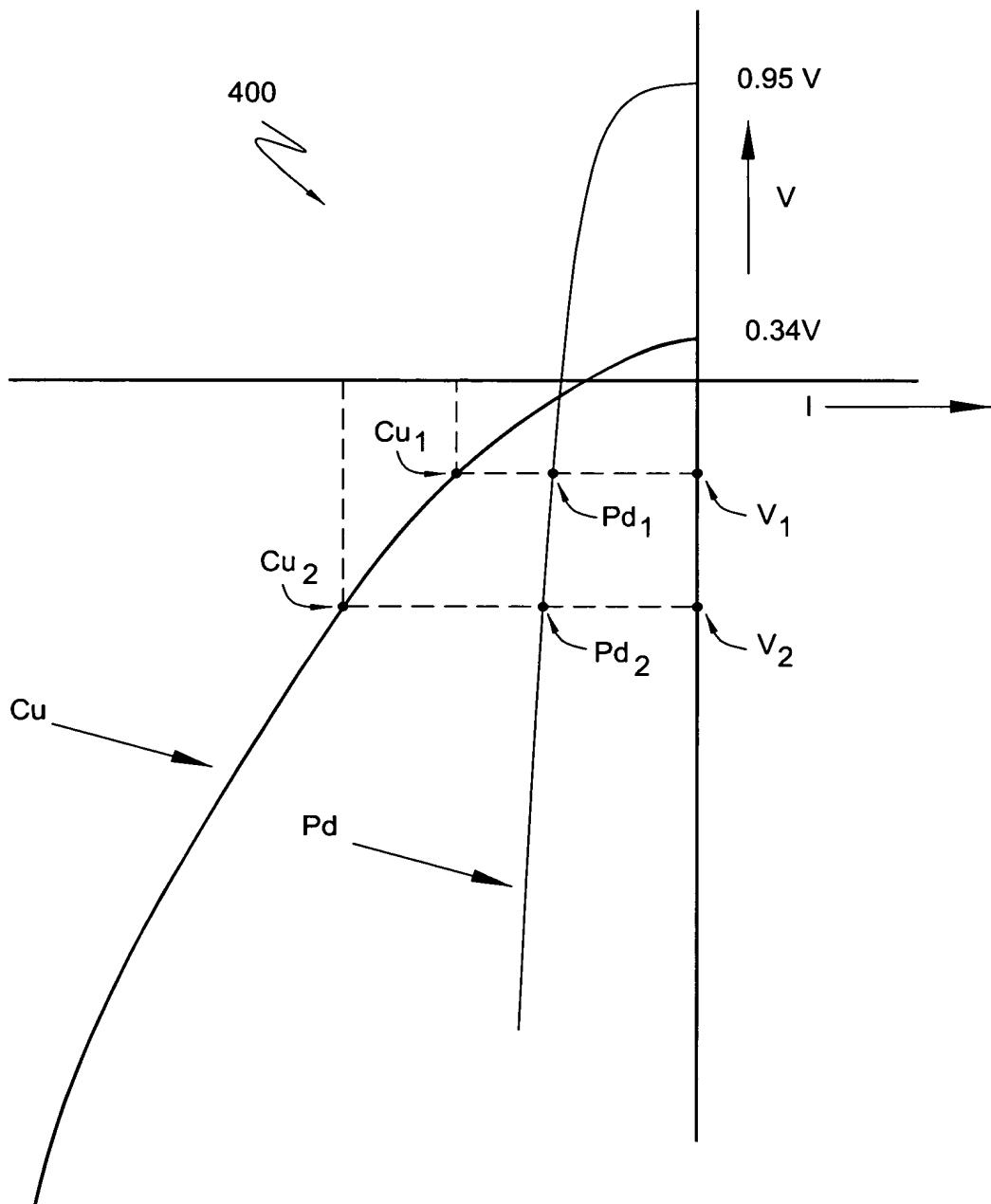


FIG. 4